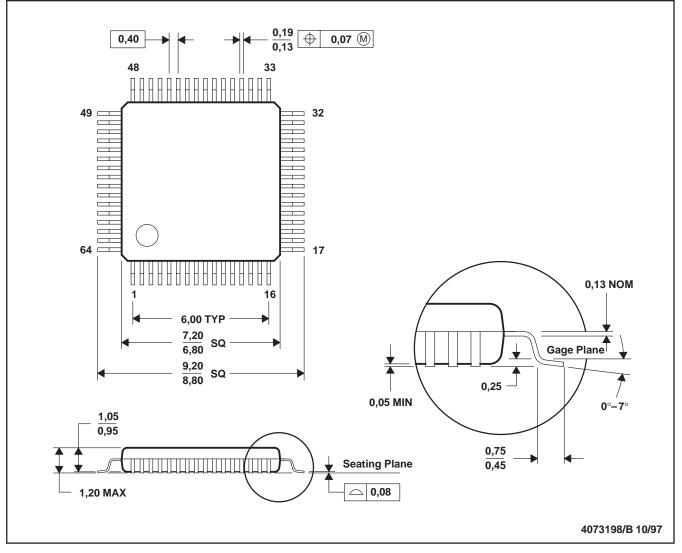
MECHANICAL DATA

MPQF039A - FEBRUARY 1997 - REVISED OCTOBER 1997

PEG (S-PQFP-G64)

PLASTIC QUAD FLATPACK



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.



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